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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Naoshi Adachi	12/21/2006

RECEIVING PARTY DATA

Name:	Sumco Corporation	
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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11702591

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NAME OF SUBMITTER:	Christopher W. Brody

Total Attachments: 1

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PATENT REEL: 019176 FRAME: 0445

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Docket No.: 12054-0075

ASSIGNMENT

This is an Assignment	of the following rights, title and interes	st:
⊠ Foreign righ	es of America rights, title and interest nts, title and interest in the invention al Application No	
Date of Filir	ng:	
☐ United State	es Patent Application Serial No	
Date of Filin	ıg:	
Title of the Invention:	HEAT TREATMENT JIG FOR SEM METHOD FOR MANUFACTURING	IICONDUCTOR SILICON SUBSTRATES AND THE SAME
Inventors (assignors):	Naoshi ADACHI	
Assignee:	SUMCO CORPORATION 2-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8634 Japan	
Whereas, we, the Invention identified above referred to as "Invention")	and described in the above-identified pa	ed certain new and useful improvements in the tent application(s) and/or patent(s) (hereinafter
And, whereas we identified assignee;	desire to assign our above-identified righ	nts, title and interest in the Invention to the above-
Now, this indentuate acknowledged;	re witnesseth, that for good and valuable	consideration, the receipt whereof is hereby
applications(s) as identifie and to any and all Letters in and to any and all reiss	ed above, including any divisions, continu Patent of the United States, which may bused ues and reexaminations thereof, and in a ng or to accrue to us with respect to the fil	ghts, title and interest in said Invention, said ations, and continuations-in-part thereof, and in the granted or have granted for said Invention, and and to any and all priority rights, Convention rights, ling of applications for patents or securing of
And we hereby at States Letters Patent which interest thereto;	uthorize and request the Commissioner o th may issue for said Invention to said As	of Patents and Trademarks to issue any United ssignee, as assignee of the whole right, title and
for filing divisions, continu- reissue or reissues of any	ations and continuations-in-part of said a	id lawful future documents, including applications, pplication for patent, and/or, for obtaining any my aforesaid Invention, as the Assignee or its expense.
<u>Naoshi A</u> Signature: Naoshi A	da chi	Date
Signature:		Date

RECORDED: 04/18/2007

PATENT REEL: 019176 FRAME: 0446